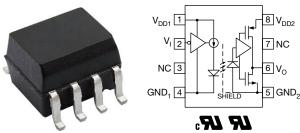


# High Speed Optocoupler, 25 MBd, SOIC-8 Package



# DESCRIPTION

The VOIH72A is a single channel 25 MBd high speed optocoupler in CMOS technology. Utilizing an input LED driver with a high speed IRED coupled with an integrated optical detector IC. A true digital input and output interface, in combination with the very low pulse width distortion of max. 6 ns and a high noise immunity of minimum 20 kV/µs enable an easy integration into digital logic systems.

### **FEATURES**

- · CMOS logic digital input and output
- · High speed data rate of 25 MBd
- Wide supply voltage range 2.7 V to 5.5 V
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912





ROHS

### **APPLICATIONS**

- Galvanic isolation in digital systems
- · Ground loop elimination
- · Digital bus system isolation
- PLC and ATE interface isolation
- · Feedback control in digital power supplies

### **AGENCY APPROVALS**

- UL 1577 (pending)
- cUL 1577 (pending)

ORDERING INFORMATION	
V O I H 7 2  PART NUMBER	PACKAGE OPTION TAPE AND REEL 6.1 mm
AGENCY CERTIFIED / PACKAGE	
UL, cUL	
SOIC-8	VOIH72AT

#### Note

· Additional options may be possible, please contact sales office

TRUTH TABLE (positive logic)				
INPUT	OUTPUT			
Н	Н			
L	L			



<b>ABSOLUTE MAXIMUM RATINGS</b> (T <sub>amb</sub> = 25 °C, unless otherwise specified)								
PARAMETER	TEST CONDITION	SYMBOL	UNIT					
INPUT								
Supply voltage		V <sub>DD1</sub>	-0.5 to 6.0	V				
Input voltage		VI	-0.5 to V <sub>DD1</sub> + 0.5	V				
Input current		I <sub>I</sub>	15	mA				
Input power dissipation		P <sub>diss</sub>	100	mW				
OUTPUT								
Supply voltage		$V_{DD2}$	-0.5 to 6.0	V				
Output voltage		$V_{O}$	-0.5 to V <sub>DD2</sub> + 0.5	V				
Output current		Io	10	mA				
Output power dissipation		P <sub>diss</sub>	50	mW				
COUPLER								
Isolation test voltage	t = 1 min	$V_{ISO}$	3750	$V_{RMS}$				
Storage temperature		T <sub>stg</sub>	-55 to +150	°C				
Operating temperature		T <sub>amb</sub>	-40 to +110	°C				
Lead solder temperature	for 10 s		260	°C				
Solder reflow temperature	for 1 min		260	°C				

#### Note

Stresses in excess of the absolute maximum ratings can cause permanent damage to the device. Functional operation of the device is not
implied at these or any other conditions in excess of those given in the operational sections of this document. Exposure to absolute
maximum ratings for extended periods of the time can adversely affect reliability.

RECOMMENDED OPERATING CONDITION							
PARAMETER	TEST CONDITION	SYMBOL	MIN.	MAX.	UNIT		
Operating temperature		T <sub>amb</sub>	-40	+110	°C		
Input supply voltage		V <sub>DD1</sub>	2.7	5.5	V		
Output supply voltage		$V_{DD2}$	2.7	5.5	V		
Logic low input voltage		V <sub>IL</sub>	0	0.8	V		
Logic high input level		V <sub>IH</sub>	2.0	V <sub>DD1</sub>	V		

<b>ELECTRICAL CHARACTERISTICS</b> ( $T_{amb}$ = -40 °C to +110 °C, 2.7 V $\leq$ V <sub>DD1</sub> $\leq$ 5.5 V, 2.7 V $\leq$ V <sub>DD2</sub> $\leq$ 5.5 V, unless otherwise specified; typical values are at V <sub>DD1</sub> = V <sub>DD2</sub> = 3.3 V, $T_{amb}$ = 25 °C)						
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
INPUT						
Input current		l <sub>l</sub>	-10	-	10	μΑ
High level supply current		I <sub>DD1H</sub>	-	0.65	5	mA
Low level supply current		I <sub>DD1L</sub>	-	9	15	mA
OUTPUT						
High level supply current		I <sub>DD2H</sub>	-	1.3	2	mA
Low level supply current		I <sub>DD2L</sub>	-	1.2	2	mA
High level output voltage	$V_I = V_{IH}, I_O = -20 \mu A$	V <sub>OH</sub>	V <sub>DD2</sub> - 0.4	$V_{DD2}$	=	V
High level output voltage	$V_I = V_{IH}$ , $I_O = -4 \text{ mA}$	V <sub>OH</sub>	V <sub>DD2</sub> - 1.4	V <sub>DD2</sub> - 0.4	=	V
Low level output voltage	$V_I = V_{IL}, I_O = 20 \mu A$	V <sub>OL</sub>	-	0	0.1	V
Low level output voltage	$V_I = V_{IL}$ , $I_O = 4 \text{ mA}$	V <sub>OL</sub>	-	0.16	0.6	V

#### Note

Minimum and maximum values are testing requirements. Typical values are characteristics of the device and are the result of engineering
evaluation. Typical values are for information only and are not part of the testing requirements.



<b>SWITCHING CHARACTERISTICS</b> ( $T_{amb} = -40  ^{\circ}\text{C}$ to +110 $^{\circ}\text{C}$ , 2.7 V $\leq$ V <sub>DD1</sub> $\leq$ 5.5 V, 2.7 V $\leq$ V <sub>DD2</sub> $\leq$ 5.5 V, unless otherwise specified; typical values are at V <sub>DD1</sub> = V <sub>DD2</sub> = 3.3 V, $T_{amb} = 25  ^{\circ}\text{C}$ )						
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
Propagation delay time to high output level	$C_L = 15 \text{ pF}, V_{IL} = 0 \text{ V}, V_{IH} = V_{DD1}$	t <sub>PLH</sub>	-	29	40	ns
Propagation delay time to low output level	$C_L = 15 \text{ pF}, V_{IL} = 0 \text{ V}, V_{IH} = V_{DD1}$	t <sub>PHL</sub>	-	24	40	ns
Pulse width distortion	$C_L = 15 \text{ pF}, V_{IL} = 0 \text{ V}, V_{IH} = V_{DD1}$	t <sub>PLH</sub> - t <sub>PHL </sub>	-	2	6	ns
Propagation delay skew	$C_L = 15 \text{ pF}, V_{IL} = 0 \text{ V}, V_{IH} = V_{DD1}$	t <sub>PSK</sub>	-	5.8	20	ns
Output rise time (10 to 90 %)	$C_L = 15 \text{ pF}, V_{IL} = 0 \text{ V}, V_{IH} = V_{DD1}$	t <sub>r</sub>	-	3.3	-	ns
Output fall time (90 to 10 %)	$C_L = 15 \text{ pF}, V_{IL} = 0 \text{ V}, V_{IH} = V_{DD1}$	t <sub>f</sub>	-	3.1	-	ns

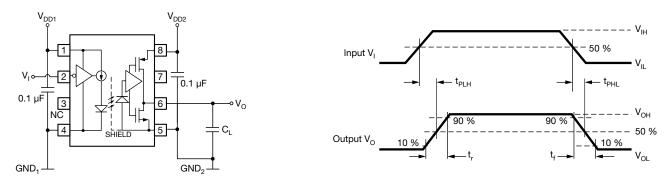


Fig. 1 - Test Circuit for  $t_{\text{PLH}},\,t_{\text{PHL}},\,t_{\text{r}}$  and  $t_{\text{f}}$ 

<b>COMMON MODE TRANSIENT IMMUNITY</b> ( $T_{amb}$ = -40 °C to +110 °C, 2.7 V $\leq$ V <sub>DD1</sub> $\leq$ 5.5 V, 2.7 V $\leq$ V <sub>DD2</sub> $\leq$ 5.5 V, unless otherwise specified; typical values are at V <sub>DD1</sub> = V <sub>DD2</sub> = 3.3 V, $T_{amb}$ = 25 °C)						
PARAMETER TEST CONDITION SYMBOL MIN. TYP. MAX. UNIT						UNIT
Common mode transient immunity (high)	$V_{CM} = 1000 \text{ V}, V_I = V_{DD1}, V_O > 0.8 \text{ x } V_{DD2}$	CM <sub>H</sub>	20 000	50 000	-	V/µs
Common mode transient immunity (low)	$V_{CM} = 1000 \text{ V}, V_I = 0 \text{ V}, V_O < 0.8 \text{ V}$	CM <sub>L</sub>	20 000	30 000	ı	V/µs

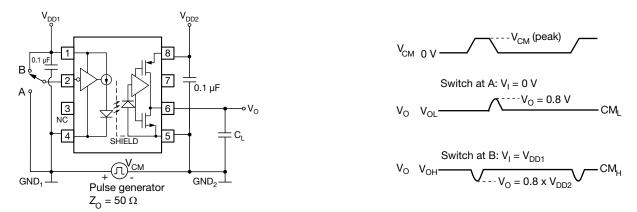


Fig. 2 - Test Circuit for Common Mode Transient Immunity



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# Vishay Semiconductors

SAFETY AND INSULATION RATINGS						
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT		
Climatic classification	According to IEC 68 part 1		40 / 110 / 21			
Pollution degree	According to DIN VDE 0109		2			
Comparative tracking index	Insulation group IIIa	CTI	175			
Maximum rated withstanding isolation voltage	According to UL 1577, t = 1 min	V <sub>ISO</sub>	3750	VRMS		
Maximum transient isolation voltage	according to DIN EN 60747-5-5	V <sub>IOTM</sub>	6000	V <sub>peak</sub>		
Maximum repetitive peak isolation voltage	according to DIN EN 60747-5-5	V <sub>IORM</sub>	560	V <sub>peak</sub>		
	$T_{amb} = 25  ^{\circ}\text{C},  V_{IO} = 500  \text{V}$	R <sub>IO</sub>	≥ 10 <sup>12</sup>	Ω		
Isolation resistance	$T_{amb} = 110  ^{\circ}\text{C},  V_{IO} = 500  \text{V}$	R <sub>IO</sub>	≥ 10 <sup>11</sup>	Ω		
	$T_{amb} = 165  ^{\circ}\text{C},  V_{IO} = 500  \text{V}$	R <sub>IO</sub>	≥ 10 <sup>9</sup>	Ω		
Output safety power		P <sub>SO</sub>	350	mW		
Input safety current		I <sub>SI</sub>	150	mA		
Input safety temperature		T <sub>S</sub>	165	°C		
Creepage distance			≥ 4	mm		
Clearance distance			≥ 4	mm		
Insulation thickness		DTI	≥ 0.2	mm		
Input to output test voltage, method B	$V_{IORM}$ x 1.875 = $V_{PR}$ , 100 % production test with $t_M$ = 1 s, partial discharge < 5 pC	$V_{PR}$	1050	V <sub>peak</sub>		
Input to output test voltage, method A	$V_{IORM}$ x 1.6 = $V_{PR}$ , 100 % sample test with $t_M$ = 10 s, partial discharge < 5 pC	V <sub>PR</sub>	896	V <sub>peak</sub>		

### Note

As per IEC 60747-5-5, 7.4.3.8.1, this optocoupler is suitable for "safe electrical insulation" only within the safety ratings. Compliance with
the safety ratings shall be ensured by means of productive circuits.

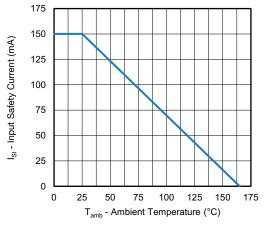


Fig. 3 - Input Safety Current vs. Ambient Temperature

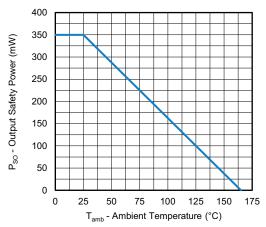


Fig. 4 - Output Safety Power vs. Ambient Temperature

### TYPICAL CHARACTERISTICS (T<sub>amb</sub> = 25 °C, unless otherwise specified)

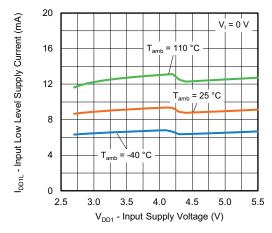


Fig. 5 - Input Low Level Supply Current vs. Input Supply Voltage

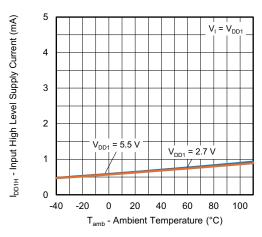


Fig. 8 - Input High Level Supply Current vs. Ambient Temperature

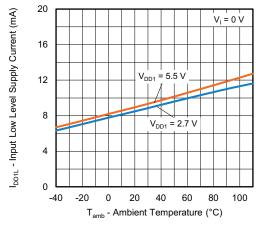


Fig. 6 - Input Low Level Supply Current vs. Ambient Temperature

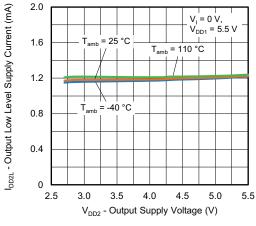


Fig. 9 - Output Low Level Supply Current vs. Output Supply Voltage

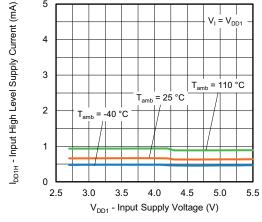


Fig. 7 - Input High Level Supply Current vs. Input Supply Voltage

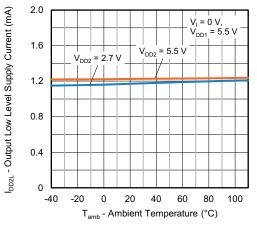


Fig. 10 - Output Low Level Supply Current vs. Ambient Temperature



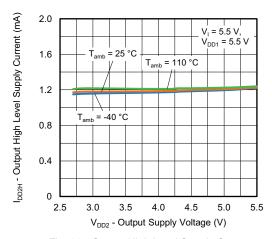


Fig. 11 - Output High Level Supply Current vs.
Output Supply Voltage

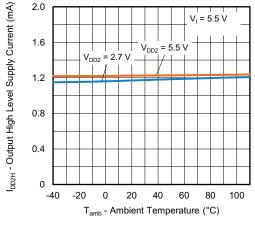


Fig. 12 - Output High Level Supply Current vs.
Ambient Temperature

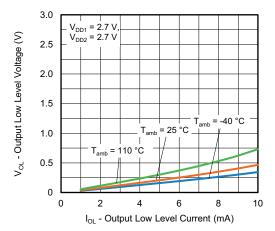


Fig. 13 - Output Low Level Voltage vs. Output Low Level Current

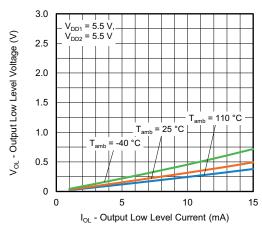


Fig. 14 - Output Low Level Voltage vs. Output Low Level Current

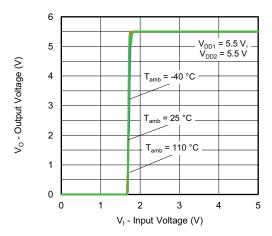


Fig. 15 - Output Voltage vs. Input Voltage

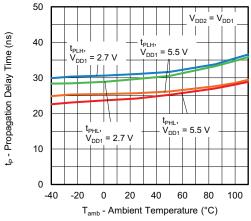


Fig. 16 - Propagation Delay Time vs. Ambient Temperature



# 10 PWD - Pulse Width Distortion (ns) 8 6 = 5.5 V 2 0 -40 0 T<sub>amb</sub> - Ambient Temperature (°C)

Fig. 17 - Pulse Width Distortion vs. Ambient Temperature

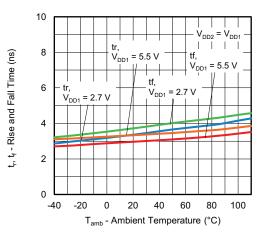
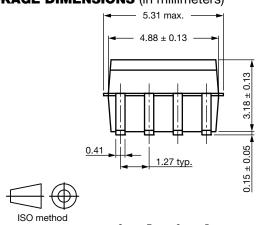
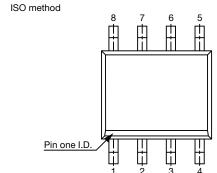
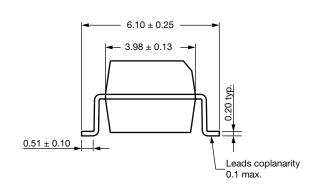


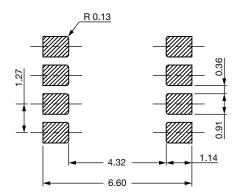
Fig. 18 - Rise and Fall Time vs. Ambient Temperature

### **PACKAGE DIMENSIONS** (in millimeters)









### **PACKAGE MARKING**



Fig. 19 - Example of VOIH72AT

# H72AX1 V XXXX 68

Fig. 20 - Example of VOIH72A-X001T

### **Notes**

- XXXX = LMC (lot marking code)
- The VDE logo is only marked on option1 (-X001) parts
- Tape and reel suffix (T) is not part of the package marking

### **PACKING INFORMATION** (in millimeters)

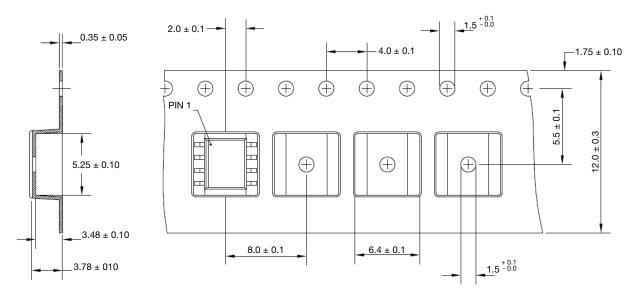


Fig. 21 - Tape and Reel Packing (2000 pieces on reel)

### **SOLDER PROFILES**

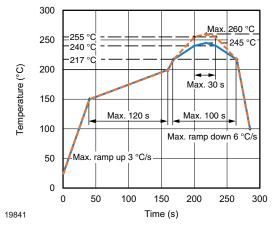


Fig. 22 - Lead (Pb)-free Reflow Solder Profile According to J-STD-020 for SMD Devices

### HANDLING AND STORAGE CONDITIONS

ESD level: HBM class 2 Floor life: unlimited

Conditions: T<sub>amb</sub> < 30 °C, RH < 85 %

Moisture sensitivity level 1, according to J-STD-020

### **ESD CAUTION**

This is an ESD (electro static discharge) sensitive device. Electrostatic charges accumulate on the human body and test equipment and can discharge without detection. Therefore, proper ESD precautions are recommended to avoid performance degradation or loss of functionality. ESD withstand voltage of this device is up to 1500 V according to JESD22-A114-B.



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